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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







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The Arria® V device family consists of the most comprehensive offerings of mid-range FPGAs ranging from the lowest power for 6 gigabits per second (Gbps) and 10 Gbps applications, to the highest midrange FPGA bandwidth 12.5 Gbps transceivers.

The Arria V devices are ideal for power-sensitive wireless infrastructure equipment, 20G/40G bridging, switching, and packet processing applications, high-definition video processing and image manipulation, and intensive digital signal processing (DSP) applications.

#### **Related Information**

#### Arria V Device Handbook: Known Issues

Lists the planned updates to the Arria V Device Handbook chapters.

# **Key Advantages of Arria V Devices**

Table 1: Key Advantages of the Arria V Device Family

Advantage	Supporting Feature			
Lowest static power in its class	<ul> <li>Built on TSMC's 28 nm process technology and includes an abundance of hard intellectual property (IP) blocks</li> <li>Power-optimized MultiTrack routing and core architecture</li> <li>Up to 50% lower power consumption than the previous generation device</li> <li>Lowest power transceivers of any midrange family</li> </ul>			
Improved logic integration and differentiation capabilities	<ul> <li>8-input adaptive logic module (ALM)</li> <li>Up to 38.38 megabits (Mb) of embedded memory</li> <li>Variable-precision digital signal processing (DSP) blocks</li> </ul>			
Increased bandwidth capacity	<ul><li>Serial data rates up to 12.5 Gbps</li><li>Hard memory controllers</li></ul>			
Hard processor system (HPS) with integrated ARM® Cortex <sup>™</sup> -A9 MPCore processor	<ul> <li>Tight integration of a dual-core ARM Cortex-A9 MPCore processor, hard IP, and an FPGA in a single Arria V system-on-a-chip (SoC)</li> <li>Supports over 128 Gbps peak bandwidth with integrated data coherency between the processor and the FPGA fabric</li> </ul>			

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Advantage	Supporting Feature
Lowest system cost	<ul> <li>Requires as few as four power supplies to operate</li> <li>Available in thermal composite flip chip ball-grid array (BGA) packaging</li> <li>Includes innovative features such as Configuration via Protocol (CvP), partial reconfiguration, and design security</li> </ul>

# **Summary of Arria V Features**

Table 2: Summary of Features for Arria V Devices

Feature	Description
Technology	<ul> <li>TSMC's 28-nm process technology:</li> <li>Arria V GX, GT, SX, and ST—28-nm low power (28LP) process</li> <li>Arria V GZ—28-nm high performance (28HP) process</li> <li>Lowest static power in its class (less than 1.2 W for 500K logic elements (LEs) at 85°C junction under typical conditions)</li> <li>0.85 V, 1.1 V, or 1.15 V core nominal voltage</li> </ul>
Packaging	<ul> <li>Thermal composite flip chip BGA packaging</li> <li>Multiple device densities with identical package footprints for seamless migration between different device densities</li> <li>Leaded<sup>(1)</sup>, lead-free (Pb-free), and RoHS-compliant options</li> </ul>
High-performance FPGA fabric	<ul> <li>Enhanced 8-input ALM with four registers</li> <li>Improved routing architecture to reduce congestion and improve compilation time</li> </ul>
Internal memory blocks	<ul> <li>M10K—10-kilobits (Kb) memory blocks with soft error correction code (ECC) (Arria V GX, GT, SX, and ST devices only)</li> <li>M20K—20-Kb memory blocks with hard ECC (Arria V GZ devices only)</li> <li>Memory logic array block (MLAB)-640-bit distributed LUTRAM where you can use up to 50% of the ALMs as MLAB memory</li> </ul>

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 $<sup>^{(1)}</sup>$  Contact Altera for availability.

Feature		Description				
Embedded Hard IP blocks	Memory controller ( Arria V GX, GT, SX, and ST only)  Embedded transceiver I/O	<ul> <li>Native support for up to four signal processing precision levels:</li> <li>Three 9 x 9, two 18 x 18, or one 27 x 27 multiplier in the same variable-precision DSP block</li> <li>One 36 x 36 multiplier using two variable-precision DSP blocks (Arria V GZ devices only)</li> <li>64-bit accumulator and cascade for systolic finite impulse responses (FIRs)</li> <li>Embedded internal coefficient memory</li> <li>Preadder/subtractor for improved efficiency</li> <li>DDR3 and DDR2</li> <li>Custom implementation: <ul> <li>Arria V GX and SX devices—up to 6.5536 Gbps</li> <li>Arria V GZ devices—up to 12.5 Gbps</li> <li>PCI Express® (PCIe®) Gen2 (x1, x2, or x4) and Gen1 (x1, x2, x4, or x8) hard IP with multifunction support, endpoint, and root port</li> <li>PCIE Gen3 (x1, x2, x4, or x8) support (Arria V GZ only)</li> <li>Gbps Ethernet (GbE) and XAUI physical coding sublayer (PCS)</li> <li>Common Public Radio Interface (CPRI) PCS</li> <li>Gigabit-capable passive optical network (GPON) PCS</li> <li>10-Gbps Ethernet (10GbE) PCS (Arria V GZ only)</li> <li>Serial RapidIO® (SRIO) PCS</li> <li>Interlaken PCS (Arria V GZ only)</li> </ul> </li> </ul>				
Clock networks	Global, quadrant, a	global clock network  nt, and peripheral clock networks  that are not used can be powered down to reduce dynamic power				
Phase-locked loops (PLLs)	(ZDB) • Integer mode and f	synthesis, clock delay compensation, and zero delay buffering				



Feature	Description
FPGA General- purpose I/Os (GPIOs)	<ul> <li>1.6 Gbps LVDS receiver and transmitter</li> <li>800 MHz/1.6 Gbps external memory interface</li> <li>On-chip termination (OCT)</li> <li>3.3 V support (2)</li> </ul>
External Memory Interface	<ul> <li>Memory interfaces with low latency:</li> <li>Hard memory controller-up to 1.066 Gbps</li> <li>Soft memory controller-up to 1.6 Gbps</li> </ul>
Low-power high- speed serial interface	<ul> <li>600 Mbps to 12.5 Gbps integrated transceiver speed</li> <li>Less than 105 mW per channel at 6 Gbps, less than 165 mW per channel at 10 Gbps, and less than 170 mW per channel at 12.5 Gbps</li> <li>Transmit pre-emphasis and receiver equalization</li> <li>Dynamic partial reconfiguration of individual channels</li> <li>Physical medium attachment (PMA) with soft PCS that supports 9.8304 Gbps CPRI (Arria V GT and ST only)</li> <li>PMA with hard PCS that supports up to 9.8 Gbps CPRI (Arria V GZ only)</li> <li>Hard PCS that supports 10GBASE-R and 10GBASE-KR (Arria V GZ only)</li> </ul>
HPS ( Arria V SX and ST devices only)	<ul> <li>Dual-core ARM Cortex-A9 MPCore processor—up to 1.05 GHz maximum frequency with support for symmetric and asymmetric multiprocessing</li> <li>Interface peripherals—10/100/1000 Ethernet media access control (EMAC), USB 2.0 On-The-GO (OTG) controller, quad serial peripheral interface (QSPI) flash controller, NAND flash controller, Secure Digital/MultiMediaCard (SD/MMC) controller, UART, serial peripheral interface (SPI), I2C interface, and up to 85 HPS GPIO interfaces</li> <li>System peripherals—general-purpose timers, watchdog timers, direct memory access (DMA) controller, FPGA configuration manager, and clock and reset managers</li> <li>On-chip RAM and boot ROM</li> <li>HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa</li> <li>FPGA-to-HPS SDRAM controller subsystem—provides a configurable interface to the multiport front end (MPFE) of the HPS SDRAM controller</li> <li>ARM CoreSight™ JTAG debug access port, trace port, and on-chip trace storage</li> </ul>



 $<sup>^{(2)}~{\</sup>rm Arria~V~GZ}$  devices support 3.3 V with a 3.0 V  ${\rm V}_{\rm CCIO}.$ 

Feature	Description
Configuration	<ul> <li>Tamper protection-comprehensive design protection to protect your valuable IP investments</li> <li>Enhanced advanced encryption standard (AES) design security features</li> <li>CvP</li> <li>Partial and dynamic reconfiguration of the FPGA</li> <li>Active serial (AS) x1 and x4, passive serial (PS), JTAG, and fast passive parallel (FPP) x8, x16, and x32 (Arria V GZ) configuration options</li> <li>Remote system upgrade</li> </ul>

# **Arria V Device Variants and Packages**

Table 3: Device Variants for the Arria V Device Family

Variant	Description
Arria V GX	FPGA with integrated 6.5536 Gbps transceivers that provides bandwidth, cost, and power levels that are optimized for high-volume data and signal-processing applications
Arria V GT	FPGA with integrated 10.3125 Gbps transceivers that provides enhanced high-speed serial I/O bandwidth for cost-sensitive data and signal processing applications
Arria V GZ	FPGA with integrated 12.5 Gbps transceivers that provides enhanced high-speed serial I/O bandwidth for high-performance and cost-sensitive data and signal processing applications
Arria V SX	SoC with integrated ARM-based HPS and 6.5536 Gbps transceivers
Arria V ST	SoC with integrated ARM-based HPS and 10.3125 Gbps transceivers

## Arria V GX

This section provides the available options, maximum resource counts, and package plan for the Arria V GX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

#### **Related Information**

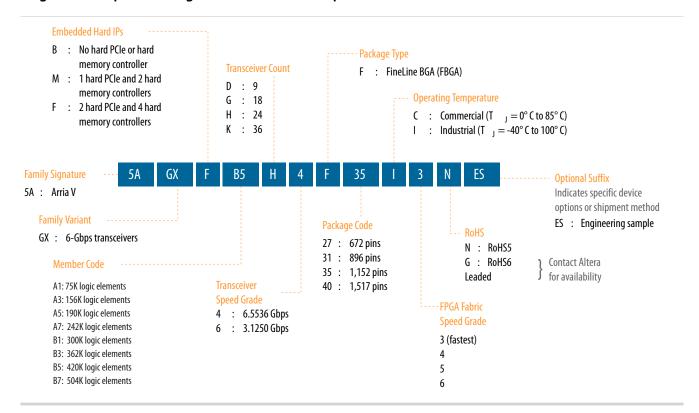
### **Altera Product Selector**

Provides the latest information about Altera products.



## **Available Options**

Figure 1: Sample Ordering Code and Available Options for Arria V GX Devices



### **Maximum Resources**

**Table 4: Maximum Resource Counts for Arria V GX Devices** 

Resource			Member Code							
neso	urce	A1	А3	<b>A</b> 5	A7	B1	В3	B5	В7	
Logic I (LE) (F	Elements (X)	75	156	190	242	300	362	420	504	
ALM		28,302	58,900	71,698	91,680	113,208	136,880	158,491	190,240	
Registe	er	113,208	235,600	286,792	366,720	452,832	547,520	633,964	760,960	
Mem	M10K	8,000	10,510	11,800	13,660	15,100	17,260	20,540	24,140	
ory (Kb)	MLAB	463	961	1,173	1,448	1,852	2,098	2,532	2,906	
Variab precisi Block	on DSP	240	396	600	800	920	1,045	1,092	1,156	
18 x 18 Multip		480	792	1,200	1,600	1,840	2,090	2,184	2,312	
PLL		10	10	12	12	12	12	16	16	



Resource		Member Code							
nesc	uice	A1	А3	A5	A7	B1	В3	B5	В7
6 Gbps Transo		9	9	24	24	24	24	36	36
GPIO <sup>(</sup>	3)	416	416	544	544	704	704	704	704
LVD S	Transmi tter	67	67	120	120	160	160	160	160
3	Receiver	80	80	136	136	176	176	176	176
PCIe I Block	Hard IP	1	1	2	2	2	2	2	2
Hard I Contro	Memory oller	2	2	4	4	4	4	4	4

High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook

Provides the number of LVDS channels in each device package.

## **Package Plan**

**Table 5: Package Plan for Arria V GX Devices** 

Member Code	F672 (27 mm)				F1152 (35 mm)		F1517 (40 mm)	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
A1	336	9	416	9	_	_	_	_
A3	336	9	416	9	_	_	_	_
A5	336	9	384	18	544	24	_	_
A7	336	9	384	18	544	24	_	_
B1	_	_	384	18	544	24	704	24
В3	_	_	384	18	544	24	704	24
B5	_	_	_	_	544	24	704	36
B7	_	_	_	_	544	24	704	36

## Arria V GT

This section provides the available options, maximum resource counts, and package plan for the Arria V GT devices.



<sup>(3)</sup> The number of GPIOs does not include transceiver I/Os. In the Quartus<sup>®</sup> Prime software, the number of user I/Os includes transceiver I/Os.

### **Available Options**

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

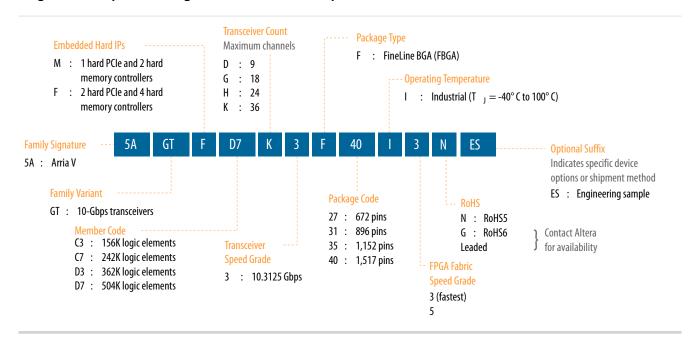
#### **Related Information**

### **Altera Product Selector**

Provides the latest information about Altera products.

### **Available Options**

Figure 2: Sample Ordering Code and Available Options for Arria V GT Devices



### **Maximum Resources**

Table 6: Maximum Resource Counts for Arria V GT Devices

Resource		Member Code					
I/C5	ouice	C3	<b>C</b> 7	D3	D7		
Logic Eleme	nts (LE) (K)	156	242	362	504		
ALM		58,900	91,680	136,880	190,240		
Register	Register		366,720	547,520	760,960		
Memory	M10K	10,510	13,660	17,260	24,140		
(Kb)	MLAB	961	1,448	2,098	2,906		
Variable-pre	Variable-precision DSP Block		800	1,045	1,156		
18 x 18 Multiplier		792	1,600	2,090	2,312		
PLL		10	12	12	16		



Resource		Member Code						
Reso	urce	<b>C</b> 3	<b>C</b> 7	D3	D7			
Transceiver	6 Gbps <sup>(4)</sup>	3 (9)	6 (24)	6 (24)	6 (36)			
Transcerver	10 Gbps <sup>(5)</sup>	4	12	12	20			
GPIO <sup>(6)</sup>	GPIO <sup>(6)</sup>		544	704	704			
LVDS	Transmitter	68	120	160	160			
LVD3	Receiver	80	136	176	176			
PCIe Hard IP Block		1	2	2	2			
Hard Memor	y Controller	2	4	4	4			

• High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook

Provides the number of LVDS channels in each device package.

• Transceiver Architecture in Arria V Devices

Describes 10 Gbps channels usage conditions and SFF-8431 compliance requirements.

## Package Plan

Table 7: Package Plan for Arria V GT Devices

Memb	F672 (27 mm)		F896 (31 mm)		F1152 (35 mm)			F1517 (40 mm)				
er Code		ХС	XCVR XCVR		XCVR			XCVR				
	GPIO	6- Gbps	10- Gbps	GPIO	6- Gbps	10- Gbps	GPIO	6- Gbps	10- Gbps	GPIO	6- Gbps	10-Gbps
C3	336	3 (9)	4	416	3 (9)	4	_	_	_	_	_	_
C7	_	_	_	384	6 (18)	8	544	6 (24)	12	_	_	_
D3	_	_	_	384	6 (18)	8	544	6 (24)	12	704	6 (24)	12
D7	_	_	_	_	_	_	544	6 (24)	12	704	6 (36)	20

The 6-Gbps transceiver counts are for dedicated 6-Gbps channels. You can also configure any pair of 10-Gbps channels as three 6-Gbps channels—the total number of 6-Gbps channels are shown in brackets. For example, you can also configure the Arria V GT D7 device in the F1517 package with nine 6-Gbps



<sup>(4)</sup> The 6 Gbps transceiver counts are for dedicated 6-Gbps channels. You can also configure any pair of 10 Gbps channels as three 6 Gbps channels-the total number of 6 Gbps channels are shown in brackets.

<sup>(5)</sup> Chip-to-chip connections only. For 10 Gbps channel usage conditions, refer to the Transceiver Architecture in Arria V Devices chapter.

<sup>(6)</sup> The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

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and eighteen 10-Gbps, twelve 6-Gbps and sixteen 10-Gbps, fifteen 6-Gbps and fourteen 10-Gbps, or up to thirty-six 6-Gbps with no 10-Gbps channels.

## Arria V GZ

This section provides the available options, maximum resource counts, and package plan for the Arria V GZ devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.

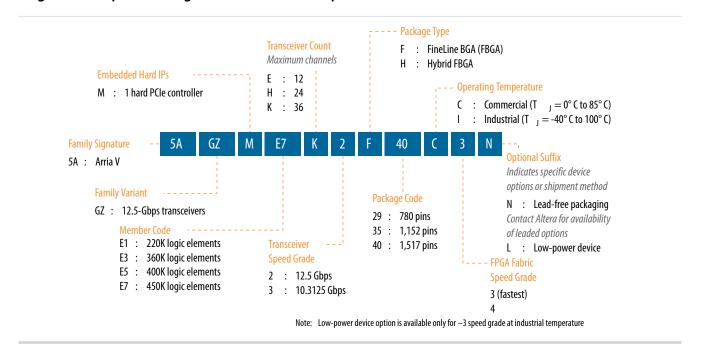
#### **Related Information**

### **Altera Product Selector**

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## **Available Options**

Figure 3: Sample Ordering Code and Available Options for Arria V GZ Devices



#### **Maximum Resources**

**Table 8: Maximum Resource Counts for Arria V GZ Devices** 

Resource	Member Code						
nesource	E1	E3	E5	E7			
Logic Elements (LE) (K)	220	360	400	450			
ALM	83,020	135,840	150,960	169,800			
Register	332,080	543,360	603,840	679,200			



Poso	Resource		Member Code						
nesc			<b>E</b> 3	<b>E</b> 5	<b>E</b> 7				
Memory	M20K	11,700	19,140	28,800	34,000				
(Kb)	MLAB	2,594	4,245	4,718	5,306				
Variable-pred	cision DSP Block	800	1,044	1,092	1,139				
18 x 18 Multi	plier	1,600	2,088	2,184	2,278				
PLL		20	20	24	24				
12.5 Gbps Tra	ansceiver	24	24	36	36				
GPIO <sup>(7)</sup>		414	414	674	674				
LVDS	Transmitter	99	99	166	166				
LVDS	Receiver	108	108	168	168				
PCIe Hard IP	Block	1	1	1	1				

High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook

Provides the number of LVDS channels in each device package.

## **Package Plan**

Table 9: Package Plan for Arria V GZ Devices

Member Code		'80 mm)		152 mm)	F1517 (40 mm)		
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	
E1	342	12	414	24	_	_	
E3	342	12	414	24	_	_	
E5	_	_	534	24	674	36	
E7	_	_	534	24	674	36	

## **Arria V SX**

This section provides the available options, maximum resource counts, and package plan for the Arria V SX devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.



<sup>&</sup>lt;sup>(7)</sup> The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

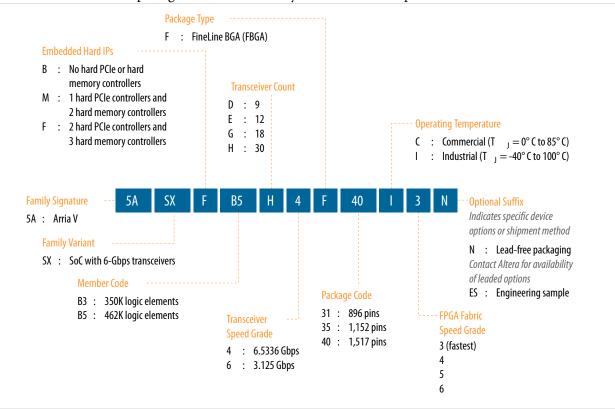
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## **Available Options**

### Figure 4: Sample Ordering Code and Available Options for Arria V SX Devices

The -3 FPGA fabric speed grade is available only for industrial temperature devices.



#### **Maximum Resources**

Table 10: Maximum Resource Counts for Arria V SX Devices

Poso	urce	Member Code			
nesu	ruice	В3	B5		
Logic Elements (LE)	(K)	350	462		
ALM		132,075	174,340		
Register		528,300	697,360		
Memory (Kb)	M10K	17,290	22,820		
Memory (Rb)	MLAB	2,014	2,658		
Variable-precision D	SP Block	809	1,090		
18 x 18 Multiplier		1,618	2,180		



Pasa	urce	Member Code			
neso	urce	В3	B5		
FPGA PLL		14	14		
HPS PLL		3	3		
6 Gbps Transceiver		30	30		
FPGA GPIO <sup>(8)</sup>		540	540		
HPS I/O		208	208		
LVDS	Transmitter	120	120		
LVD3	Receiver	136	136		
PCIe Hard IP Block		2	2		
FPGA Hard Memory	Controller	3	3		
HPS Hard Memory C	Controller	1	1		
ARM Cortex-A9 MP	Core Processor	Dual-core	Dual-core		

High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook

Provides the number of LVDS channels in each device package.

## Package Plan

## Table 11: Package Plan for Arria V SX Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

		F896			F1152		F1517			
Member Code		(31 mm)			(35 mm)		(40 mm)			
Code	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR	
В3	250	208	12	385	208	18	540	208	30	
B5	250	208	12	385	208	18	540	208	30	

## Arria V ST

This section provides the available options, maximum resource counts, and package plan for the Arria V ST devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Altera Product Selector.



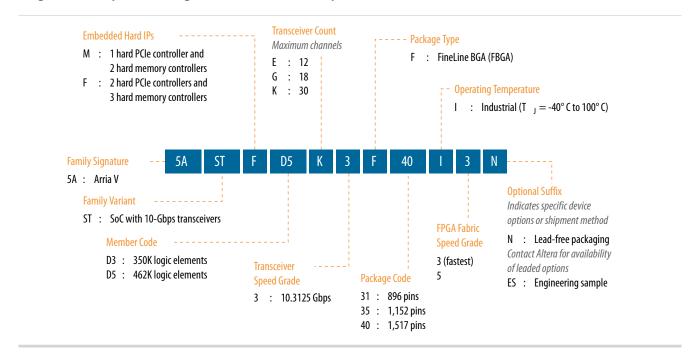
<sup>(8)</sup> The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

#### **Altera Product Selector**

Provides the latest information about Altera products.

## **Available Options**

Figure 5: Sample Ordering Code and Available Options for Arria V ST Devices



### **Maximum Resources**

**Table 12: Maximum Resource Counts for Arria V ST Devices** 

Dose	urce	Member Code			
Reso	ource	D3	D5		
Logic Elements (LE)	(K)	350	462		
ALM		132,075	174,340		
Register		528,300	697,360		
Memory (Kb)	M10K	17,290	22,820		
Memory (Rb)	MLAB	2,014	2,658		
Variable-precision D	SP Block	809	1,090		
18 x 18 Multiplier		1,618	2,180		
FPGA PLL		14	14		
HPS PLL		3	3		
Transceiver	6-Gbps	30	30		
Transcerver	10-Gbps <sup>(9)</sup>	16	16		



Pose	ource	Member Code			
nesu	ruice	D3	D5		
FPGA GPIO <sup>(10)</sup>		540	540		
HPS I/O		208	208		
LVDS	Transmitter	120	120		
L V D3	Receiver	136	136		
PCIe Hard IP Block		2	2		
FPGA Hard Memory	PGA Hard Memory Controller		3		
HPS Hard Memory C	PS Hard Memory Controller		1		
ARM Cortex-A9 MP	Core Processor	Dual-core	Dual-core		

• High-Speed Differential I/O Interfaces and DPA in Arria V Devices chapter, Arria V Device Handbook

Provides the number of LVDS channels in each device package.

Transceiver Architecture in Arria V Devices
 Describes 10 Gbps channels usage conditions and SFF-8431 compliance requirements.

### **Package Plan**

### Table 13: Package Plan for Arria V ST Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Marila			96 mm)		F1152 (35 mm)				F1517 (40 mm)			
Memb er Code	FPGA	HPS	(31 mm) XCVR		FPGA HPS XCVR			FPGA HPS XCVR			KCVR	
	GPIO	1/0	6 Gbps	10 Gbps	GPIO	1/0	6 Gbps	10 Gbps	GPIO	1/0	6 Gbps	10 Gbps
D3	250	208	12	6	385	208	18	8	540	208	30	16
D5	250	208	12	6	385	208	18	8	540	208	30	16



 $<sup>^{(9)}</sup>$  Chip-to-chip connections only. For 10 Gbps channel usage conditions, refer to the Transceiver Architecture in Arria V Devices chapter.

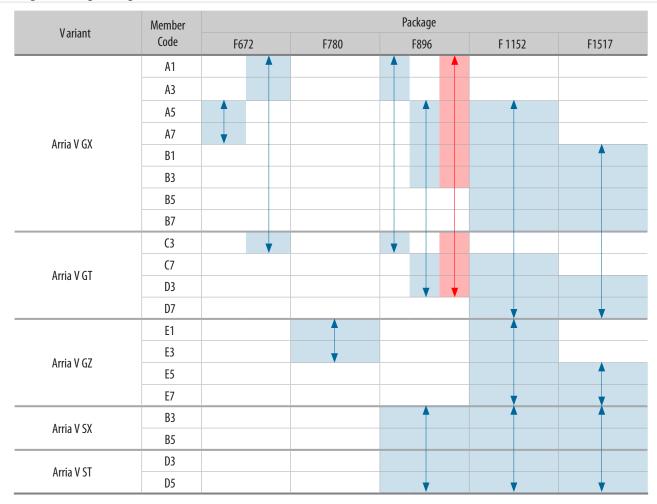
<sup>(10)</sup> The number of GPIOs does not include transceiver I/Os. In the Quartus Prime software, the number of user I/Os includes transceiver I/Os.

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# I/O Vertical Migration for Arria V Devices

### Figure 6: Vertical Migration Capability Across Arria V Device Packages and Densities

The arrows indicate the vertical migration paths. Some packages have several migration paths. The devices included in each vertical migration path are shaded. You can also migrate your design across device densities in the same package option if the devices have the same dedicated pins, configuration pins, and power pins.



You can achieve the vertical migration shaded in red if you use only up to 320 GPIOs, up to nine 6 Gbps transceiver channels, and up to four 10 Gbps transceiver (for Arria V GT devices). This migration path is not shown in the Quartus Prime software Pin Migration View.

**Note:** To verify the pin migration compatibility, use the Pin Migration View window in the Quartus Prime software Pin Planner.

Note: Except for Arria V GX A5 and A7, and Arria V GT C7 devices, all other Arria V GX and GT devices require a specific power-up sequence. If you plan to migrate your design from Arria V GX A5 and A7, and Arria V GT C7 devices to other Arria V devices, your design must adhere to the same required power-up sequence.



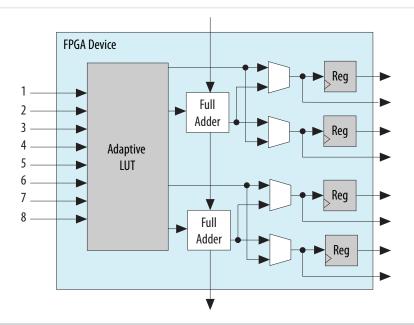
- Managing Device I/O Pins chapter, Quartus Prime Handbook Provides more information about vertical I/O migrations.
- Power Management in Arria V Devices
   Describes the power-up sequence required for Arria V GX and GT devices.

# **Adaptive Logic Module**

Arria V devices use a 28 nm ALM as the basic building block of the logic fabric.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than previous generations.

Figure 7: ALM for Arria V Devices



You can configure up to 50% of the ALMs in the Arria V devices as distributed memory using MLABs.

### **Related Information**

**Embedded Memory Capacity in Arria V Devices** on page 20 Lists the embedded memory capacity for each device.



## Variable-Precision DSP Block

Arria V devices feature a variable-precision DSP block that supports these features:

- Configurable to support signal processing precisions ranging from 9 x 9, 18 x 18, 27 x 27, and 36 x 36 bits natively
- A 64-bit accumulator
- Double accumulator
- A hard preadder that is available in both 18- and 27-bit modes
- Cascaded output adders for efficient systolic finite impulse response (FIR) filters
- Dynamic coefficients
- 18-bit internal coefficient register banks
- Enhanced independent multiplier operation
- Efficient support for single-precision floating point arithmetic
- The inferability of all modes by the Quartus Prime design software

### Table 14: Variable-Precision DSP Block Configurations for Arria V Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resource		
Low precision fixed point for video applications	Three 9 x 9	1		
Medium precision fixed point in FIR filters	Two 18 x 18	1		
FIR filters	Two 18 x 18 with accumulate	1		
Single-precision floating- point implementations	One 27 x 27	1		
Very high precision fixed point implementations	One 36 x 36	2		

You can configure each DSP block during compilation as independent three 9 x 9, two 18 x 18, or one  $27 \times 27$  multipliers. Using two DSP block resources, you can also configure a  $36 \times 36$  multiplier for high-precision applications. With a dedicated 64 bit cascade bus, you can cascade multiple variable-precision DSP blocks to implement even higher precision DSP functions efficiently.



**Table 15: Number of Multipliers in Arria V Devices** 

The table lists the variable-precision DSP resources by bit precision for each Arria V device.

Variant	Mem ber	r precision	Independ	ent Input and Ope	iplications	18 x 18 Multiplier	18 x 18 Multiplier Adder Summed	
Variant	Code		9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier	36 x 36 Multiplier	Adder Mode	with 36 bit Input
	A1	240	720	480	240	_	240	240
	A3	396	1,188	792	396	_	396	396
	A5	600	1,800	1,200	600	_	600	600
Arria V	A7	800	2,400	1,600	800	_	800	800
GX	B1	920	2,760	1,840	920	_	920	920
	В3	1,045	3,135	2,090	1,045	_	1,045	1,045
	B5	1,092	3,276	2,184	1,092	_	1,092	1,092
	B7	1,156	3,468	2,312	1,156	_	1,156	1,156
	C3	396	1,188	792	396	_	396	396
Arria V	C7	800	2,400	1,600	800	_	800	800
GT	D3	1,045	3,135	2,090	1,045	_	1,045	1,045
	D7	1,156	3,468	2,312	1,156	_	1,156	1,156
	E1	800	2,400	1,600	800	400	800	800
Arria V	E3	1,044	3,132	2,088	1,044	522	1,044	1,044
GZ	E5	1,092	3,276	2,184	1,092	546	1,092	1,092
	E7	1,139	3,417	2,278	1,139	569	1,139	1,139
Arria V	В3	809	2,427	1,618	809	_	809	809
SX	B5	1,090	3,270	2,180	1,090	_	1,090	1,090
Arria V	D3	809	2,427	1,618	809	_	809	809
ST	D5	1,090	3,270	2,180	1,090	_	1,090	1,090

# **Embedded Memory Blocks**

The embedded memory blocks in the devices are flexible and designed to provide an optimal amount of small- and large-sized memory arrays to fit your design requirements.



# **Types of Embedded Memory**

The Arria V devices contain two types of memory blocks:

- 20 Kb M20K or 10 Kb M10K blocks—blocks of dedicated memory resources. The M20K and M10K blocks are ideal for larger memory arrays while still providing a large number of independent ports.
- 640 bit memory logic array blocks (MLABs)—enhanced memory blocks that are configured from dual-purpose logic array blocks (LABs). The MLABs are ideal for wide and shallow memory arrays. The MLABs are optimized for implementation of shift registers for digital signal processing (DSP) applications, wide shallow FIFO buffers, and filter delay lines. Each MLAB is made up of ten adaptive logic modules (ALMs). In the Arria V devices, you can configure these ALMs as ten 32 x 2 blocks, giving you one 32 x 20 simple dual-port SRAM block per MLAB. You can also configure these ALMs, in Arria V GZ devices, as ten 64 x 1 blocks, giving you one 64 x 10 simple dual-port SRAM block per MLAB.

# **Embedded Memory Capacity in Arria V Devices**

Table 16: Embedded Memory Capacity and Distribution in Arria V Devices

		M20K		M10K		MLAB		
Variant	Membe r Code	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	Total RAM Bit (Kb)
Arria V GX	A1	_	_	800	8,000	741	463	8,463
	A3	_	_	1,051	10,510	1538	961	11,471
	A5	_	_	1,180	11,800	1877	1,173	12,973
	A7	_	_	1,366	13,660	2317	1,448	15,108
	B1	_	_	1,510	15,100	2964	1,852	16,952
	В3	_	_	1,726	17,260	3357	2,098	19,358
	B5	_	_	2,054	20,540	4052	2,532	23,072
	В7	_	_	2,414	24,140	4650	2,906	27,046
Arria V GT	C3	_	_	1,051	10,510	1538	961	11,471
	C7	_	_	1,366	13,660	2317	1,448	15,108
	D3	_	_	1,726	17,260	3357	2,098	19,358
	D7	_	_	2,414	24,140	4650	2,906	27,046
Arria V GZ	E1	585	11,700	_	_	4,151	2,594	14,294
	E3	957	19,140	_	_	6,792	4,245	23,385
	E5	1,440	28,800	_	_	7,548	4,718	33,518
	E7	1,700	34,000	_	_	8,490	5,306	39,306
Arria V SX	В3	_	_	1,729	17,290	3223	2,014	19,304
	B5	_	_	2,282	22,820	4253	2,658	25,478



		M20K		M10K		MLAB		
Variant	Membe r Code	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	Total RAM Bit (Kb)
Arria V ST	D3	_	_	1,729	17,290	3223	2,014	19,304
Allia V 31	D5	_	_	2,282	22,820	4253	2,658	25,478

# **Embedded Memory Configurations**

## Table 17: Supported Embedded Memory Block Configurations for Arria V Devices

This table lists the maximum configurations supported for the embedded memory blocks. The information is applicable only to the single-port RAM and ROM modes.

Memory Block	Depth (bits)	Programmable Width		
MLAB	32	x16, x18, or x20		
	64 <sup>(11)</sup>	x10		
	512	x40		
	1K	x20		
M20K	2K	x10		
WIZUK	4K	x5		
	8K	x2		
	16K	x1		
	256	x40 or x32		
	512	x20 or x16		
M10K	1K	x10 or x8		
WITOK	2K	x5 or x4		
	4K	x2		
	8K	x1		

# **Clock Networks and PLL Clock Sources**

650 MHz Arria V devices have 16 global clock networks capable of up to operation. The clock network architecture is based on Altera's global, quadrant, and peripheral clock structure. This clock structure is supported by dedicated clock input pins and fractional PLLs.

**Note:** To reduce power consumption, the Quartus Prime software identifies all unused sections of the clock network and powers them down.



<sup>(11)</sup> Available for Arria V GZ devices only.

#### **PLL Features**

The PLLs in the Arria V devices support the following features:

- Frequency synthesis
- On-chip clock deskew
- Jitter attenuation
- Counter reconfiguration
- Programmable output clock duty cycles
- PLL cascading
- Reference clock switchover
- Programmable bandwidth
- Dynamic phase shift
- · Zero delay buffers

#### **Fractional PLL**

In addition to integer PLLs, the Arria V devices use a fractional PLL architecture. The devices have up to 16 PLLs, each with 18 output counters. One fractional PLL can use up to 18 output counters and two adjacent fractional PLLs share the 18 output counters. You can use the output counters to reduce PLL usage in two ways:

- Reduce the number of oscillators that are required on your board by using fractional PLLs
- Reduce the number of clock pins that are used in the device by synthesizing multiple clock frequencies from a single reference clock source

If you use the fractional PLL mode, you can use the PLLs for precision fractional-N frequency synthesis—removing the need for off-chip reference clock sources in your design.

The transceiver fractional PLLs that are not used by the transceiver I/Os can be used as general purpose fractional PLLs by the FPGA fabric.

# FPGA General Purpose I/O

Arria V devices offer highly configurable GPIOs. The following list describes the features of the GPIOs:

- Programmable bus hold and weak pull-up
- LVDS output buffer with programmable differential output voltage ( $V_{OD}$ ) and programmable preemphasis
- $\bullet$  On-chip parallel termination (R<sub>T</sub> OCT) for all I/O banks with OCT calibration to limit the termination impedance variation
- On-chip dynamic termination that has the ability to swap between series and parallel termination, depending on whether there is read or write on a common bus for signal integrity
- Unused voltage reference ( VREF ) pins that can be configured as user I/Os ( Arria V GX, GT, SX, and ST only)
- Easy timing closure support using the hard read FIFO in the input register path, and delay-locked loop (DLL) delay chain with fine and coarse architecture



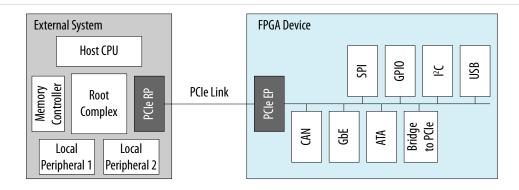
# PCIe Gen1, Gen2, and Gen 3 Hard IP

Arria V devices contain PCIe hard IP that is designed for performance and ease-of-use. The PCIe hard IP consists of the MAC, data link, and transaction layers.

The PCIe hard IP supports PCIe Gen3, Gen 2, and Gen 1 end point and root port for up to x8 lane configuration.

The PCIe endpoint support includes multifunction support for up to eight functions, as shown in the following figure. The integrated multifunction support reduces the FPGA logic requirements by up to 20,000 LEs for PCIe designs that require multiple peripherals.

Figure 8: PCIe Multifunction for Arria V Devices



The Arria V PCIe hard IP operates independently from the core logic. This independent operation allows the PCIe link to wake up and complete link training in less than 100 ms while the Arria V device completes loading the programming file for the rest of the device.

In addition, the PCIe hard IP in the Arria V device provides improved end-to-end datapath protection using ECC.

# **External Memory Interface**

This section provides an overview of the external memory interface in Arria V devices.

# **Hard and Soft Memory Controllers**

Arria V GX,GT, SX, and ST devices support up to four hard memory controllers for DDR3 and DDR2 SDRAM devices. Each controller supports 8 to 32 bit components of up to 4 gigabits (Gb) in density with two chip selects and optional ECC. For the Arria V SoC devices, an additional hard memory controller in the HPS supports DDR3, DDR2, and LPDDR2 SDRAM devices.

All Arria V devices support soft memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices, QDR II+, QDR II, and DDR II+ SRAM devices, and RLDRAM II devices for maximum flexibility.

**Note:** DDR3 SDRAM leveling is supported only in Arria V GZ devices.



# **External Memory Performance**

Table 18: External Memory Interface Performance in Arria V Devices

Interface	Voltage (V)	Hard Controller (MHz)	Soft Controller (MHz)		
interiace		Arria V GX, GT, SX, and ST	Arria V GX, GT, SX, and ST	Arria V GZ	
DDR3 SDRAM	1.5	533	667	800	
DDK3 3DKAM	1.35	533	600	800	
DDR2 SDRAM	1.8	400	400	400	
LPDDR2 SDRAM	1.2	_	400	_	
RLDRAM 3	1.2	_	_	667	
RLDRAM II	1.8	_	400	533	
	1.5	_	400	533	
QDR II+ SRAM	1.8	_	400	500	
	1.5	_	400	500	
QDR II SRAM	1.8	_	400	333	
	1.5	_	400	333	
DDR II+ SRAM <sup>(12)</sup>	1.8	_	400	_	
	1.5	_	400	_	

#### **Related Information**

### **External Memory Interface Spec Estimator**

For the latest information and to estimate the external memory system performance specification, use Altera's External Memory Interface Spec Estimator tool.

# **HPS External Memory Performance**

### **Table 19: HPS External Memory Interface Performance**

The hard processor system (HPS) is available in Arria V SoC devices only.

Interface	Voltage (V)	HPS Hard Controller (MHz)
DDR3 SDRAM	1.5	533
DDR3 SDRAM	1.35	533
LPDDR2 SDRAM	1.2	333



<sup>(12)</sup> Not available as Altera® IP.

### **External Memory Interface Spec Estimator**

For the latest information and to estimate the external memory system performance specification, use Altera's External Memory Interface Spec Estimator tool.

## **Low-Power Serial Transceivers**

Arria V devices deliver the industry's lowest power consumption per transceiver channel:

- 12.5 Gbps transceivers at less than 170 mW
- 10 Gbps transceivers at less than 165 mW
- 6 Gbps transceivers at less than 105 mW

Arria V transceivers are designed to be compliant with a wide range of protocols and data rates.

## **Transceiver Channels**

The transceivers are positioned on the left and right outer edges of the device. The transceiver channels consist of the physical medium attachment (PMA), physical coding sublayer (PCS), and clock networks.

The following figures are graphical representations of a top view of the silicon die, which corresponds to a reverse view for flip chip packages. Different Arria V devices may have different floorplans than the ones shown in the figures.

